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Kind regards,

Team Nexperia

DATA SHEET

74LVT16543A

3.3V LVT 16-bit registered transceiver (3-State)

Product specification
Supersedes data of 19
IC23 Data Handbook

1998 Feb 19

Philips
Semiconductors

PHILIPS

3.3V 16-bit registered transceiver (3-State) 74LVT16543A

FEATURES

- 16-bit universal bus interface
- 3-State buffers
- Output capability: +64mA/-32mA
- TTL input and output switching levels
- Input and output interface capability to systems at 5V supply
- Bus-hold data inputs eliminate the need for external pull-up resistors to hold unused inputs
- Live insertion/extraction permitted
- Power-up 3-State
- Power-up reset
- No bus current loading when output is tied to 5V bus
- Latch-up protection exceeds 500mA per JEDEC Std 17
- ESD protection exceeds 2000V per MIL STD 883 Method 3015 and 200V per Machine Model

DESCRIPTION

The 74LVT16543A is a high-performance BiCMOS product designed for V_{CC} operation at 3.3V. The device can be used as two 8-bit transceivers or one 16-bit transceiver.

The 74LVT16543A contains two sets of eight D-type latches, with separate control pins for each set. Using data flow from A to B as an example, when the A-to-B Enable ($n\overline{EAB}$) input and the A-to-B Latch Enable ($n\overline{LEAB}$) input are Low, the A-to-B path is transparent.

A subsequent Low-to-High transition of the $n\overline{LEAB}$ signal puts the A data into the latches where it is stored and the B outputs no longer change with the A inputs. With $n\overline{EAB}$ and $n\overline{OEAB}$ both Low, the 3-State B output buffers are active and display the data present at the outputs of the A latches.

Control of data flow from B to A is similar, but using the $n\overline{EBA}$, $n\overline{LEBA}$, and $n\overline{OEBA}$ inputs.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

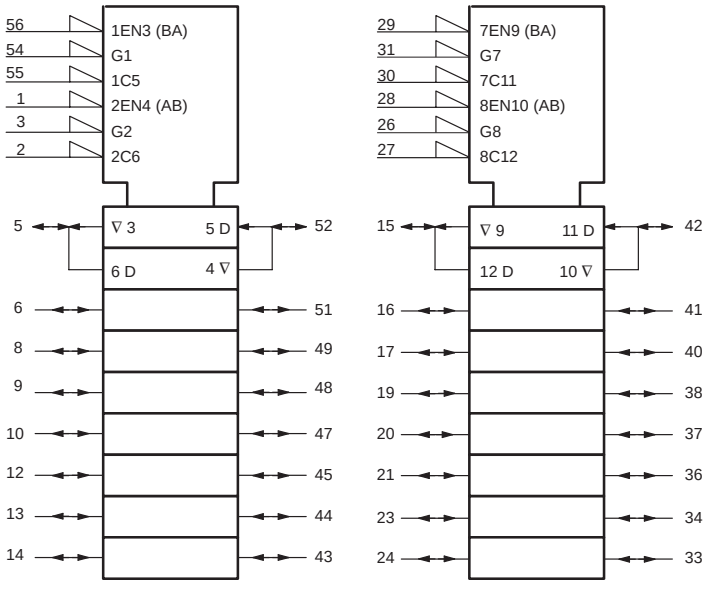
QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS T_{amb} = 25°C; GND = 0V	TYPICAL	UNIT
t_{PLH} t_{PHL}	Propagation delay nAx to nBx or nBx to nAx	C_L = 50pF; V_{CC} = 3.3V	2.2	ns
C_{IN}	Input capacitance control pins	V_I = 0V or 3.0V	3	pF
$C_{I/O}$	I/O pin capacitance	Outputs disabled; $V_{I/O}$ = 0V or 3.0V	9	pF
I_{CCZ}	Total supply current	Outputs disabled; V_{CC} = 3.6V	70	µA

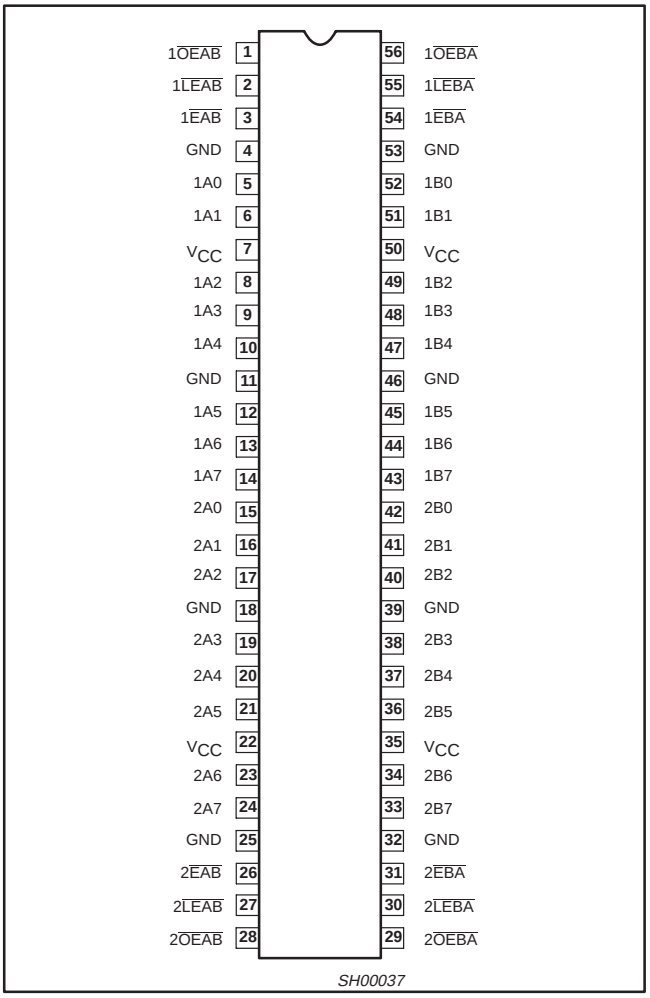
ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
56-Pin Plastic SSOP Type III	–40°C to +85°C	74LVT16543A DL	VT16543A DL	SOT371-1
56-Pin Plastic TSSOP Type II	–40°C to +85°C	74LVT16543A DGG	VT16543A DGG	SOT364-1

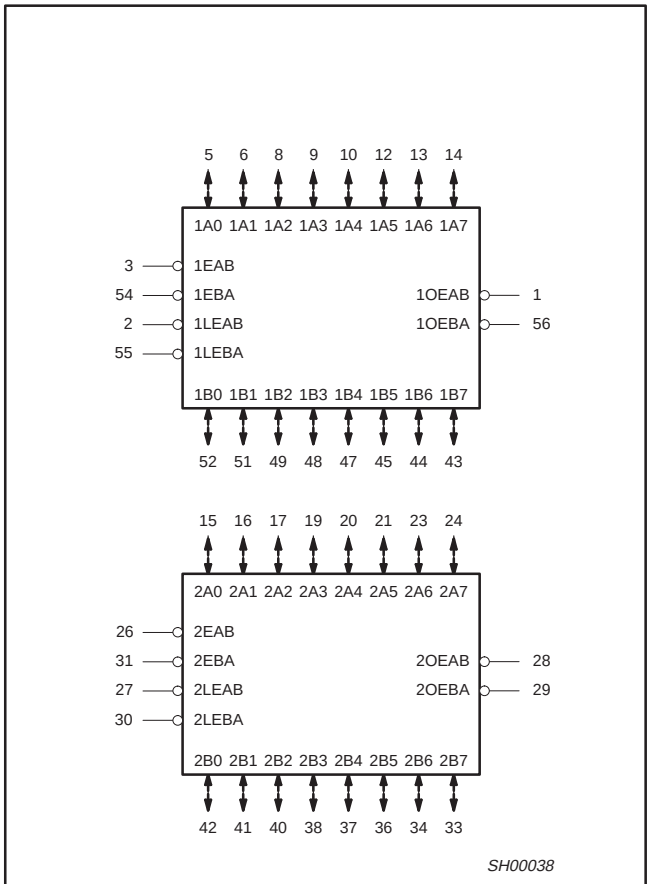
LOGIC SYMBOL (IEEE/IEC)



PIN CONFIGURATION



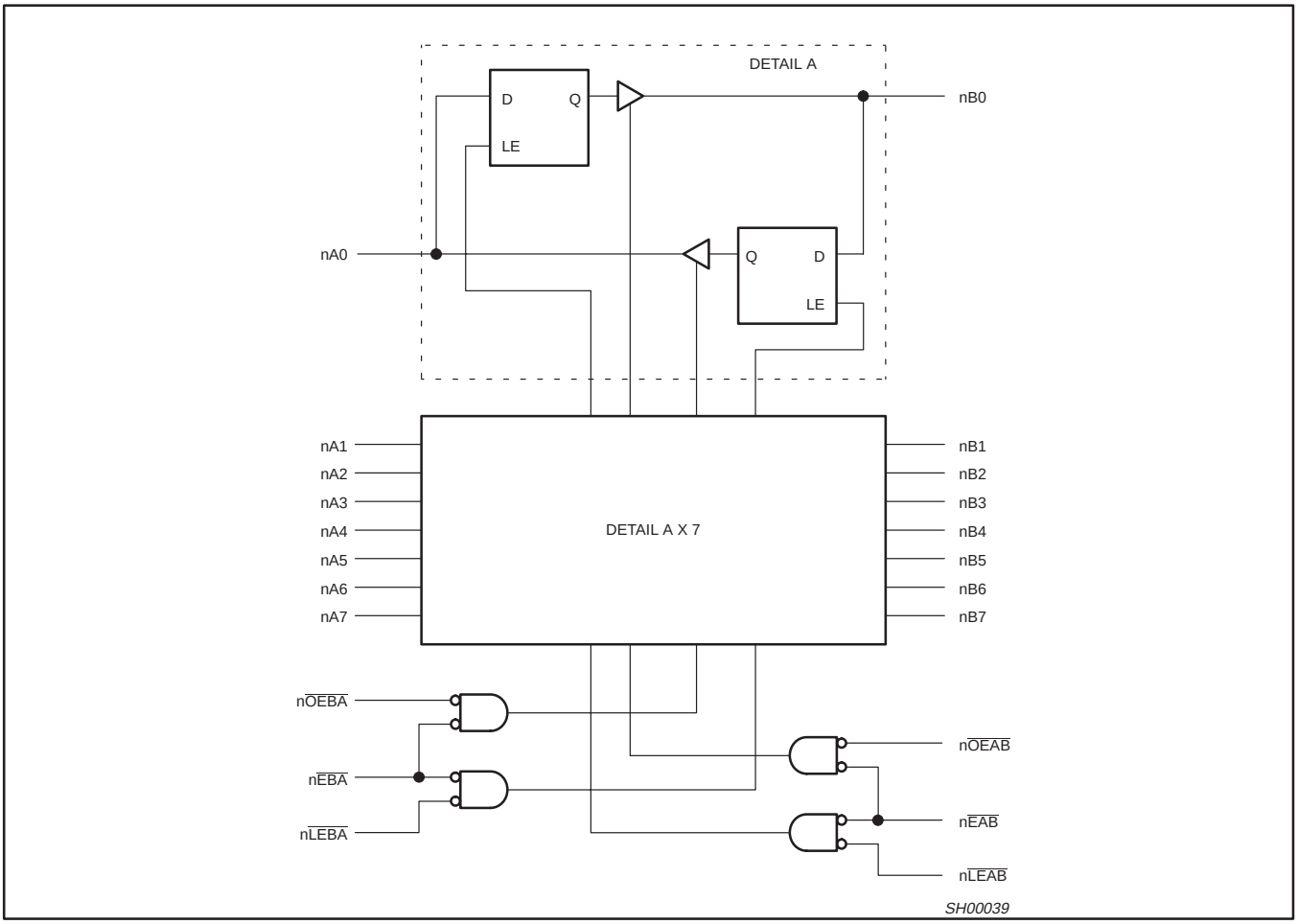
LOGIC SYMBOL



PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
5, 6, 8, 9, 10, 12, 13, 14 15, 16, 17, 19, 20, 21, 23, 24	1A0 – 1A7, 2A0 – 2A7	A Data inputs/outputs
52, 51, 49, 48, 47, 45, 44, 43 42, 41, 40,38, 37, 36, 34, 33	1B0 – 1B7, 2B0 – 2B7	B Data inputs/outputs
1, 56 28, 29	$1\overline{OEAB}$, $1\overline{OEBA}$, $2\overline{OEAB}$, $2\overline{OEBA}$	A to B / B to A Output Enable inputs (active-Low)
3, 54 26, 31	$1\overline{EAB}$, $1\overline{EBA}$, $2\overline{EAB}$, $2\overline{EBA}$	A to B / B to A Enable inputs (active-Low)
2, 55 27, 30	$1\overline{LEAB}$, $1\overline{LEBA}$, $2\overline{LEAB}$, $2\overline{LEBA}$	A to B / B to A Latch Enable inputs (active-Low)
4, 11, 18, 25, 32, 39, 46, 53	GND	Ground (0V)
7, 22, 35, 50	V_{CC}	Positive supply voltage

LOGIC DIAGRAM



FUNCTION TABLE

INPUTS				OUTPUTS	STATUS
$nOEXX$	$nEXX$	$nLEXX$	nAx or nBx	nBx or nAx	
H	X	X	X	Z	Disabled
X	H	X	X	Z	Disabled
L L	↑ ↑	L L	h l	Z Z	Disabled + Latch
L L	L L	↑ ↑	h l	H L	Latch + Display
L L	L L	L L	H L	H L	Transparent
L	L	H	X	NC	Hold

H = High voltage level
h = High voltage level one set-up time prior to the Low-to-High transition of $nLEXX$ or $nEXX$ (XX = AB or BA)
L = Low voltage level
l = Low voltage level one set-up time prior to the Low-to-High transition of $nLEXX$ or $nEXX$ (XX = AB or BA)
X = Don't care
↑ = Low-to-High transition of $nLEXX$ or $nEXX$ (XX = AB or BA)
NC= No change
Z = High impedance or "off" state

ABSOLUTE MAXIMUM RATINGS[1, 2]

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V_{CC}	DC supply voltage		–0.5 to +4.6	V
I_{IK}	DC input diode current	$V_I < 0$	–50	mA
V_I	DC input voltage[3]		–0.5 to +7.0	V
I_{OK}	DC output diode current	$V_O < 0$	–50	mA
V_{OUT}	DC output voltage[3]	Output in Off or High state	–0.5 to +7.0	V
I_{OUT}	DC output current	Output in Low state	128	mA
		Output in High state	–64	
T_{stg}	Storage temperature range		–65 to +150	°C

NOTES:
1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
3. The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS		UNIT
		MIN	MAX	
V_{CC}	DC supply voltage	2.7	3.6	V
V_I	Input voltage	0	5.5	V
V_{IH}	High-level input voltage	2.0		V
V_{IL}	Input voltage		0.8	V
I_{OH}	High-level output current		–32	mA
I_{OL}	Low-level output current		32	mA
	Low-level output current; current duty cycle ≤ 50%; f ≥ 1kHz		64	
$\Delta t/\Delta v$	Input transition rise or fall rate; Outputs enabled		10	ns/V
T_{amb}	Operating free-air temperature range	–40	+85	°C

DC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITIONS		LIMITS			UNIT
				Temp = -40°C to +85°C			
				MIN	TYP[1]	MAX	
V_{IK}	Input clamp voltage	V_{CC} = 2.7V; I_{IK} = –18mA			–0.85	–1.2	V
V_{OH}	High-level output voltage	V_{CC} = 2.7 to 3.6V; I_{OH} = –100µA		V_{CC}–0.2	V_{CC}		V
		V_{CC} = 2.7V; I_{OH} = –8mA		2.4	2.54		
		V_{CC} = 3.0V; I_{OH} = –32mA		2.0	2.36		
V_{OL}	Low-level output voltage	V_{CC} = 2.7V; I_{OL} = 100µA			0.07	0.2	V
		V_{CC} = 2.7V; I_{OL} = 24mA			0.3	0.5	
		V_{CC} = 3.0V; I_{OL} = 16mA			0.2	0.4	
		V_{CC} = 3.0V; I_{OL} = 32mA			0.3	0.5	
		V_{CC} = 3.0V; I_{OL} = 64mA			0.35	0.55	
V_{RST}	Power-up output low voltage[5]	V_{CC} = 3.6V; I_O = 1mA; V_I = GND or V_{CC}			0.13	0.55	V
I_I	Input leakage current	V_{CC} = 3.6V; V_I = V_{CC} or GND	Control pins		0.1	±1	µA
		V_{CC} = 0 or 3.6V; V_I = 5.5V			0.1	10	
		V_{CC} = 3.6V; V_I = 5.5V	I/O Data pins[4]		0.5	20	
		V_{CC} = 3.6V; V_I = V_{CC}			0.5	10	
		V_{CC} = 3.6V; V_I = 0			1.0	–5	
I_{OFF}	Output off current	V_{CC} = 0V; V_I or V_O = 0 to 4.5V			1.0	±100	µA
I_{HOLD}	Bus Hold current A or B outputs[7]	V_{CC} = 3V; V_I = 0.8V		75	130		µA
		V_{CC} = 3V; V_I = 2.0V		–75	–140		
		V_{CC} = 0V to 3.6V; V_{CC} = 3.6V		±500			
I_{EX}	Current into an output in the High state when $V_O > V_{CC}$	V_O = 5.5V; V_{CC} = 3.0V			45	125	µA
$I_{PU/PD}$	Power up/down 3-State output current[3]	$V_{CC} \leq$ 1.2V; V_O = 0.5V to V_{CC}; V_I = GND or V_{CC}; $\overline{OE}$/OE = Don't care			35	±100	µA
I_{CCH}	Quiescent supply current	V_{CC} = 3.6V; Outputs High, V_I = GND or V_{CC}, I_O = 0			0.07	0.12	mA
I_{CCL}		V_{CC} = 3.6V; Outputs Low, V_I = GND or V_{CC}, I_O = 0			4.5	6	
I_{CCZ}		V_{CC} = 3.6V; Outputs Disabled; V_I = GND or V_{CC}, I_O = 0[6]			0.07	0.12	
ΔI_{CC}	Additional supply current per input pin[2]	V_{CC} = 3V to 3.6V; One input at V_{CC}-0.6V, Other inputs at V_{CC} or GND			0.1	0.2	mA

NOTES:
1. All typical values are at V_{CC} = 3.3V and .
2. This is the increase in supply current for each input at the specified voltage level other than V_{CC} or GND
3. This parameter is valid for any V_{CC} between 0V and 1.2V with a transition time of up to 10msec. From V_{CC} = 1.2V to V_{CC} = 3.3V ± 0.3V a transition time of 100µsec is permitted. This parameter is valid for T_{amb} = 25°C only.
4. Unused pins at V_{CC} or GND.
5. For valid test results, data must not be loaded into the flip-flops (or latches) after applying power.
6. I_{CCZ} is measured with outputs pulled to V_{CC} or GND.
7. This is the bus hold overdrive current required to force the input to the opposite logic state.

AC CHARACTERISTICS

GND = 0V; $t_R = t_F$ = 2.5ns; C_L = 50pF; R_L = 500Ω; T_{amb} = –40°C to +85°C.

SYMBOL	PARAMETER	WAVEFORM	LIMITS				UNIT
			V_{CC} = 3.3V ±0.3V			V_{CC} = 2.7V	
			MIN	TYP[1]	MAX	MAX	
t_{PLH} t_{PHL}	Propagation delay nAx to nBx or nBx to nAx	2	1.0 1.0	2.2 2.2	3.7 3.7	4.4 4.4	ns
t_{PLH} t_{PHL}	Propagation delay n$\overline{LEBA}$ to nAx, n$\overline{LEAB}$ to nBx	1 2	1.5 1.5	2.7 2.7	4.8 4.8	6.2 6.2	ns
t_{PZH} t_{PZL}	Output enable time n$\overline{OEBA}$ to nAx, n$\overline{OEAB}$ to nBx	4 5	1.5 1.5	2.8 2.6	4.6 5.0	6.1 6.6	ns
t_{PHZ} t_{PLZ}	Output disable time n$\overline{OEBA}$ to nAx, n$\overline{OEAB}$ to nBx	4 5	2.0 2.0	3.1 3.2	5.2 4.6	5.7 4.7	ns
t_{PZH} t_{PZL}	Output enable time n$\overline{EBA}$ to nAx, n$\overline{EAB}$ to nBx	4 5	1.5 1.5	2.9 2.6	4.8 5.1	6.1 6.6	ns
t_{PHZ} t_{PLZ}	Output disable time n$\overline{EBA}$ to nAx, n$\overline{EAB}$ to nBx	4 5	2.0 2.0	3.1 3.2	5.1 4.3	5.7 4.5	ns

NOTE:
1. All typical values are at V_{CC} = 3.3V and T_{amb} = 25°C.

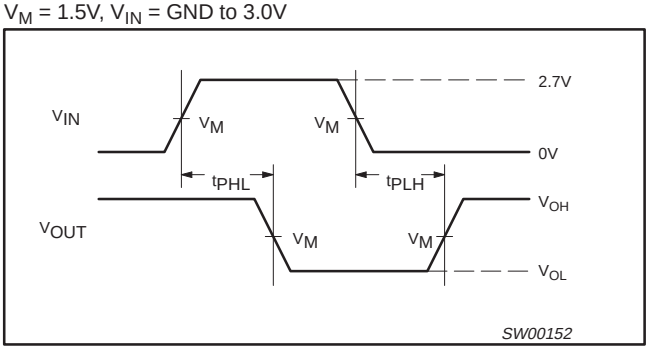
AC SETUP REQUIREMENTS

GND = 0V; $t_R = t_F$ = 2.5ns; C_L = 50pF; R_L = 500Ω; T_{amb} = –40°C to +85°C.

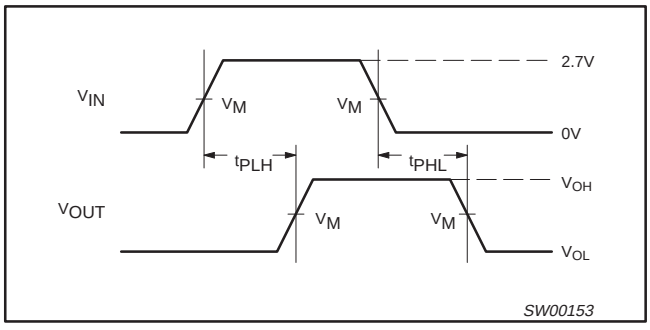
SYMBOL	PARAMETER	WAVEFORM	LIMITS			UNIT
			V_{CC} = 3.3V ±0.3V		V_{CC} = 2.7V	
			MIN	TYP	MIN	
t_s(H) t_s(L)	Setup time nAx to n$\overline{LEAB}$, nBx to n$\overline{LEBA}$	3	0.8 1.0	0.4 0.1	0.5 1.5	ns
t_h(H) t_h(L)	Hold time nAx to n$\overline{LEAB}$, nBx to n$\overline{LEBA}$	3	1.0 1.2	0.2 0.4	0.5 1.3	ns
t_s(H) t_s(L)	Setup time nAx to n$\overline{EAB}$, nBx to n$\overline{EBA}$	3	0.7 1.3	0.1 0.1	0.4 1.5	ns
t_h(H) t_h(L)	Hold time nAx to n$\overline{EAB}$, nBx to n$\overline{EBA}$	3	1.2 1.3	0.2 0.4	0.8 1.4	ns
t_W(L)	Latch enable pulse width, Low	3	1.8	1.0	1.8	ns

AC WAVEFORMS

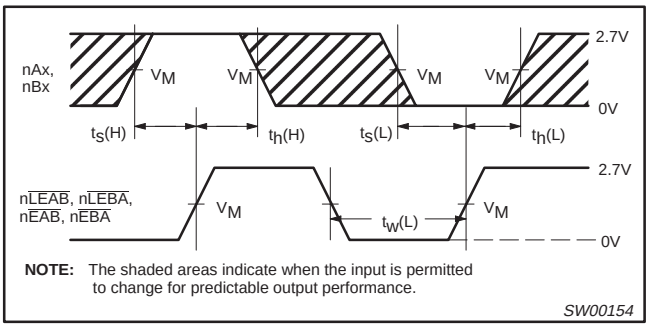
V_M = 1.5V, V_{IN} = GND to 3.0V



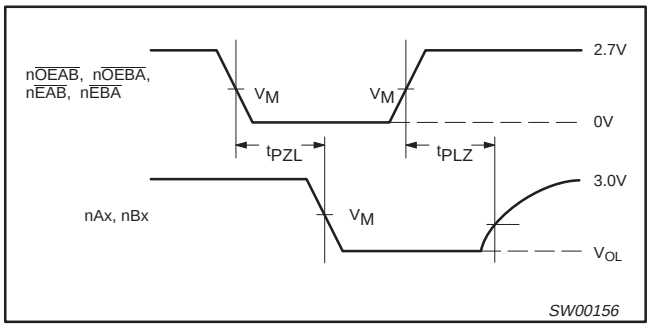
Waveform 1. Propagation Delay For Inverting Output



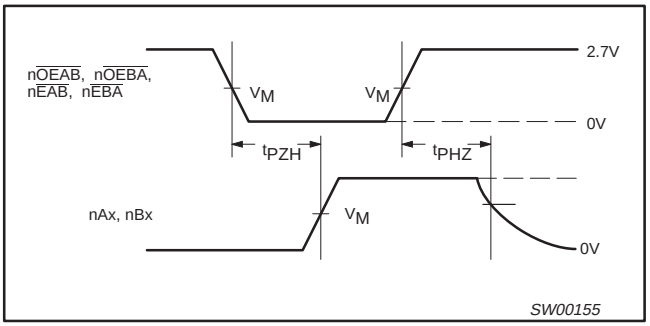
Waveform 2. Propagation Delay For Non-Inverting Output



Waveform 3. Data Setup and Hold Times and Latch Enable Pulse Width

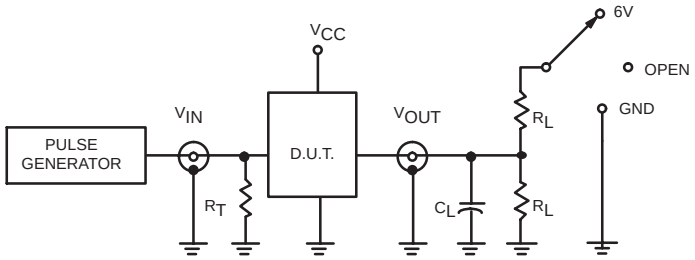


Waveform 5. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

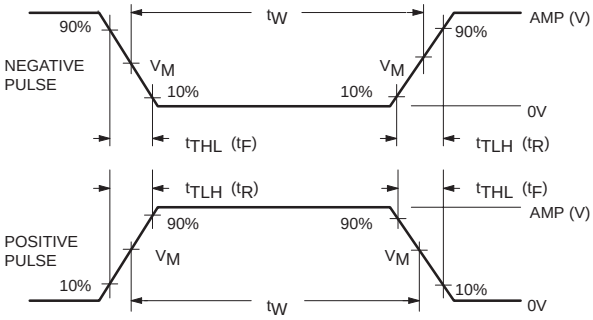


Waveform 4. 3-State Output Enable Time to High Level and Output Disable Time from High Level

TEST CIRCUIT AND WAVEFORMS



Test Circuit for 3-State Outputs



V_M = 1.5V
Input Pulse Definition

SWITCH POSITION

TEST	SWITCH
t_{PHZ}/t_{PZH}	GND
t_{PLZ}/t_{PZL}	6V
t_{PLH}/t_{PHL}	open

DEFINITIONS

R_L = Load resistor; see AC CHARACTERISTICS for value.

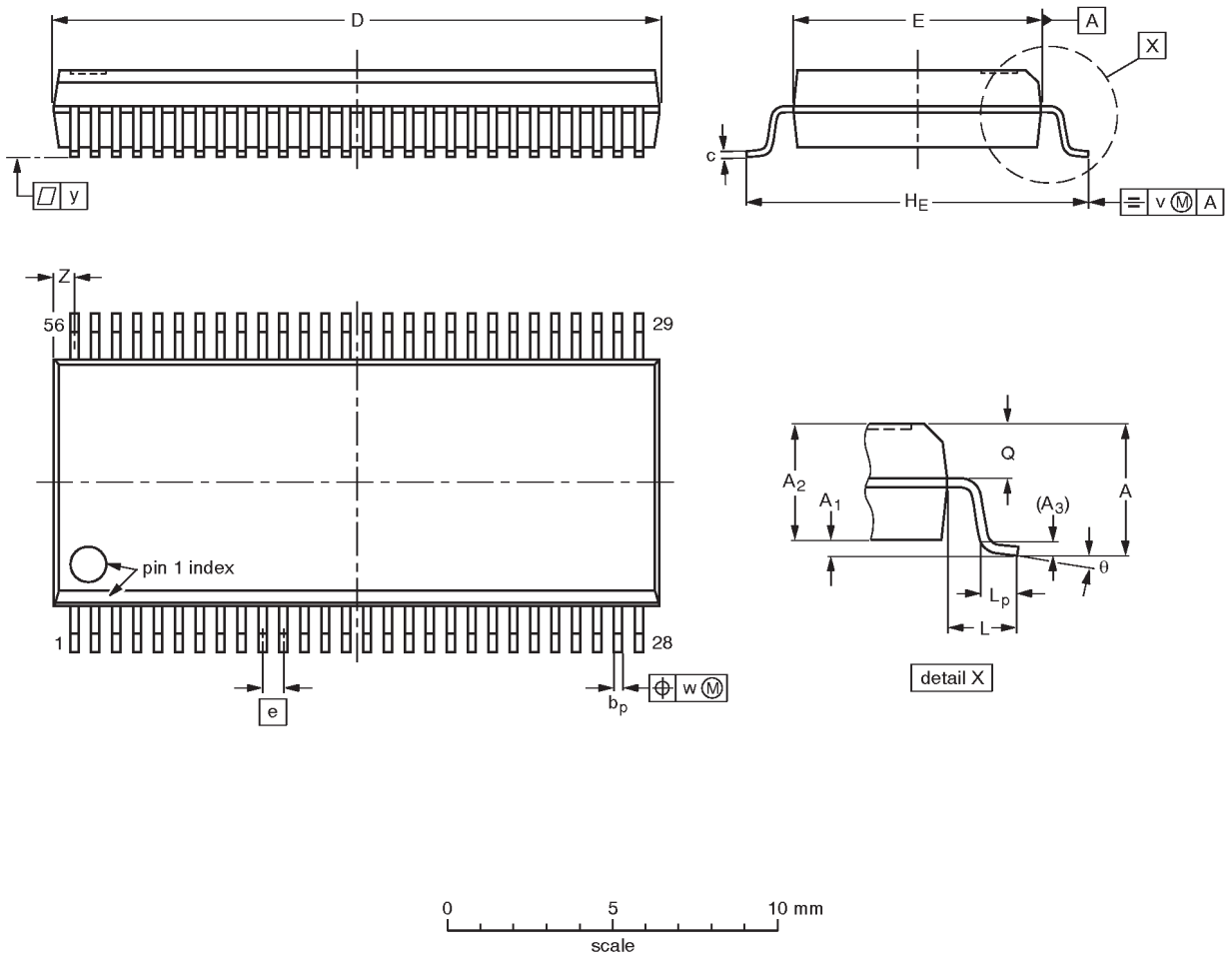
C_L = Load capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.

R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.

FAMILY	INPUT PULSE REQUIREMENTS				
	Amplitude	Rep. Rate	t_W	t_R	t_F
74LVT16	2.7V	≤10MHz	500ns	≤2.5ns	≤2.5ns

SW00003

SSOP56: plastic shrink small outline package; 56 leads; body width 7.5 mm **SOT371-1**



DIMENSIONS (mm are the original dimensions)

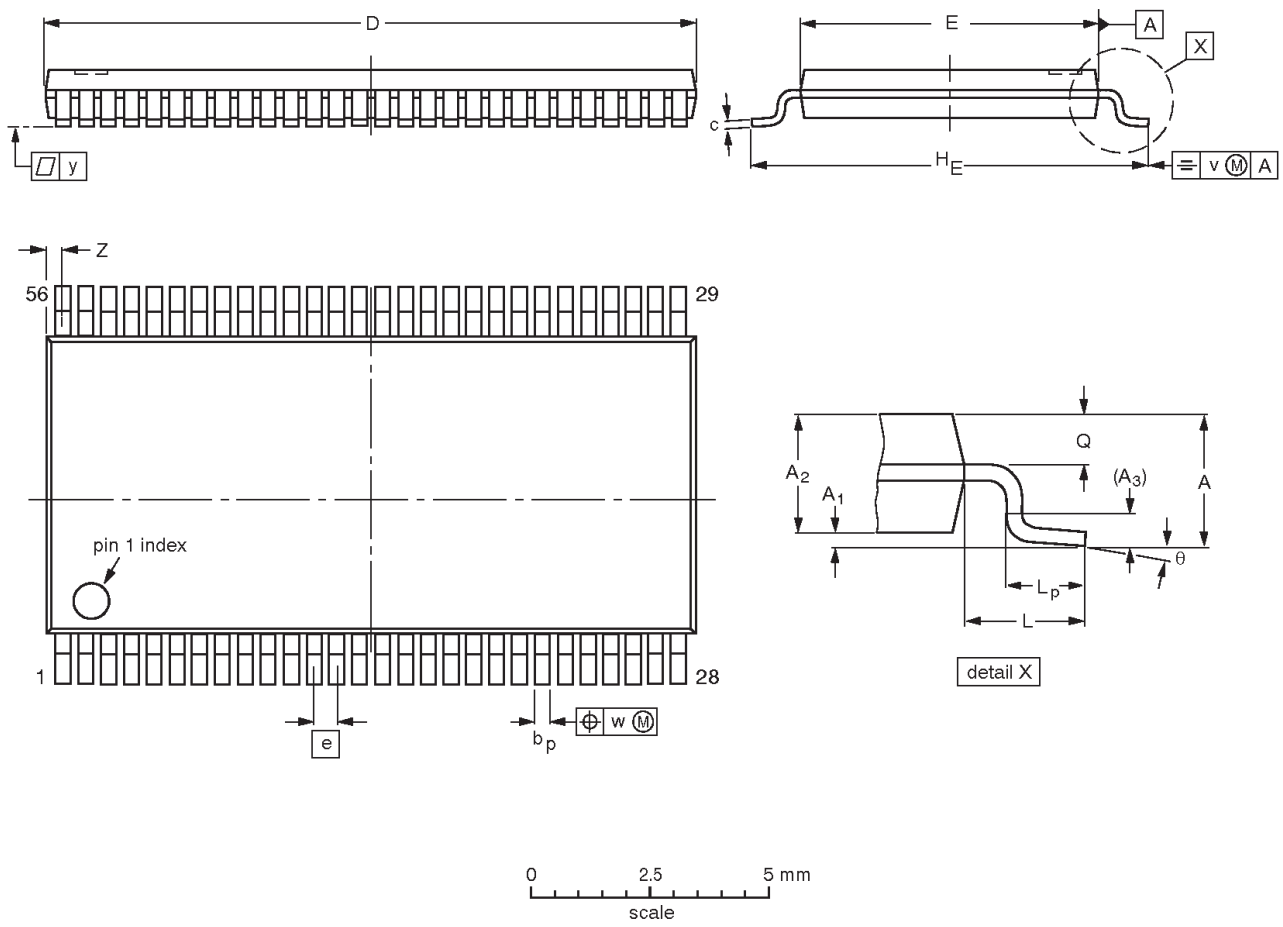
UNIT	A max.	A_1	A_2	A_3	b_p	c	D (1)	E (1)	e	H_E	L	L_p	Q	v	w	y	Z (1)	θ
mm	2.8	0.4 0.2	2.35 2.20	0.25	0.3 0.2	0.22 0.13	18.55 18.30	7.6 7.4	0.635	10.4 10.1	1.4	1.0 0.6	1.2 1.0	0.25	0.18	0.1	0.85 0.40	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT371-1		MO-118AB				~~93-11-02~~ 95-02-04

TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1mm **SOT364-1**



DIMENSIONS (mm are the original dimensions).

UNIT	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(2)}$	e	H_E	L	L_p	Q	v	w	y	Z	θ
mm	1.2	0.15 0.05	1.05 0.85	0.25	0.28 0.17	0.2 0.1	14.1 13.9	6.2 6.0	0.5	8.3 7.9	1.0	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.5 0.1	8^o 0^o

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES					EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ				
SOT364-1		MO-153EE					~~93-02-03~~ 95-02-10

NOTES

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
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[1] Please consult the most recently issued datasheet before initiating or completing a design.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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